

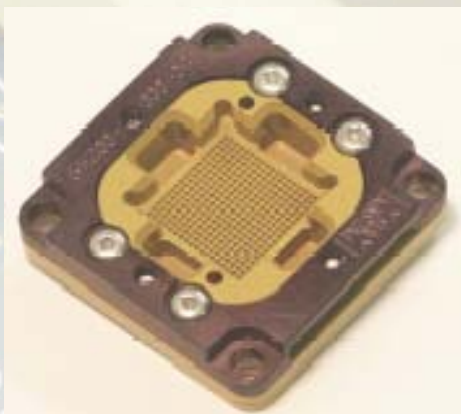
M&M Specialties, Inc.

SMALL BGA SOCKET WITH CLIP-N LID

The M&M Small BGA Socket is designed for a up to 18 mm BGA package. It will work for .5mm to 1.27mm pitch device. It has a floating plate design to help locate the device before contact with the spring probe. The standard lid has a dual latch for easy manual operation. The lid snaps on and off for easy change from manual to handler and back.

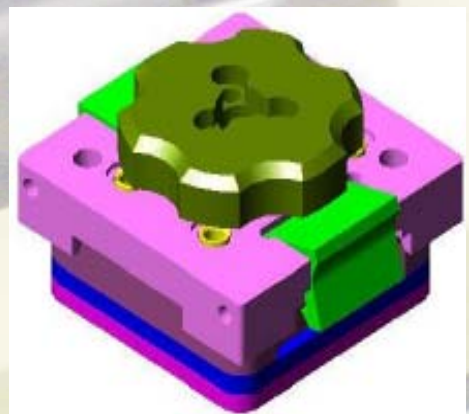
We offer three lids with this socket.

1. Standard Lid, offers automatic adjustment for package variance.
2. Z Adjust Lid, can adjust for more package variance.
3. Die Probing Lid, for open die probing of device.



Small BGA Socket

Solid Model
with Z axis Lid



OPTIONAL LIDS:

Standard Lid



Z adjust lid



DIE Probing Lid

